Supporting Information

Temperature Role in the Recombination Reaction on Dye-Sensitized Solar Cells

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Figure S1. Photographs of the (a) laser sealed half-cells and (b) dye-sensitized solar cells: 1 – drilled hole for temperature measurement; 2 – electrical contact; 3 – electrical terminal; 4 – glass frit sealing; 5 – electrolyte filling hole.



Figure S2. Experimental setup used for temperature control of an under illumination DSC between -5 °C and 105 °C. 1-Keithley DC supply; 2-Newport solar simulator; 3-temperature control unit; 4- NI acquisition board; 5- solar simulator ; 6- cooling fluid lines; 7- DSC electrical connections to autolab potentiostat; 8- aluminum slab with drilled thermal fluid circuit; 9 –thermocouple T_2 ; 10 – peltier device; 11 – DSC; 12- thermocouple T_1 ; thermocouple T_3 ; 14 – electrical connections from peltier device to Keithley DC supply



Figure S3. Temperature measurements of an illuminated DSC (100mW·cm⁻², AM 1.5); with and without temperature control.



Figure S4*. I-V* and power density curves for a DSC before and after sustaining the temperature analysis range from 0 to 100 °C. Lines were added for readability.

Parameter	Before temperature tests	After temperature tests 0.777 10.8 5.95 0.712	
$V_{ m OC}$ / ${ m V}$	0.773		
$J_{\rm SC}$ / mA.cm ⁻²	11.3		
MMP / mW.cm ⁻²	5.72		
FF	0.655		
η / %	5.83	6.07	

 Table S1. Performance parameters, obtained at 25°C, of samples that underwent the temperature analysis, before and after the tests.



Figure S5. Performance parameters *vs* time since preparation of samples that underwent the temperature analysis (0 to 100°C): $V_{\rm OC}$ – open circuit voltage; $J_{\rm SC}$ – short circuit current density; FF – fill factor; η - photo conversion efficiency. Lines were added for readability.



Figure S6. Electrical analogue used for fitting the electrochemical impedance spectra of half-cells. R_s – series resistances ; R_{CE} – charge transfer at catalytic interface; C_{CE} double layer capacitance at catalytic interface; Z_d - Nernst diffusion within electrolyte



Figure S7. Transmission line model used to fit EIS experimental data of DSCs. R_s – series resistances; $R_{TCO/EL}$ – charge transfer resistance at exposed TCO/electrolyte interface; $C_{TCO/EL}$ double layer capacitance at exposed TCO/electrolyte interface; R_k – recombination resistance; R_w – transport resistance; c_{μ} – chemical capacitance; Z_d -Nernst diffusion within electrolyte; R_{CE} – charge transfer at platinum/TCO interface; C_{CE} double layer capacitance at the platinum/TCO interface

Parameter	Batch n°					
	<i>k</i> ₁	<i>k</i> ₂	<i>k</i> ₃	<i>k</i> ₄	<i>k</i> ₅	
<i>V</i> _{OC,25°C} / V	0.719±0.003	0.727±0.004	0.734±0.005	0.739±0.005	0.777±0.008	
J _{SC,25°C} / mA.cm ⁻²	7.67±0.40	9.03±0.05	9.95±0.43	10.27±0.45	11.53±0.41	
FF,25°C	0.641±0.046	0.632±0.046	0.665±0.012	0.645±0.032	0.638±0.035	
$\eta_{ m ,25^{o}C}$ / %	3.60±0.08	4.23±0.31	4.86±0.12	4.99±0.18	5.80±0.16	

 Table S2. Performance parameters at 25°C of the five batches of DSCs presented in